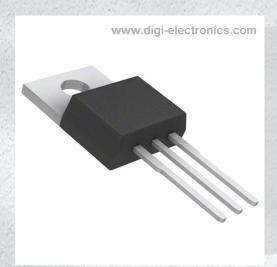


# FDP100N10 Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number FDP100N10-DG

Manufacturer onsemi

Manufacturer Product Number FDP100N10

Description MOSFET N-CH 100V 75A TO220-3

Detailed Description N-Channel 100 V 75A (Tc) 208W (Tc) Through Hole

TO-220-3



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



# **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
FDP100N10	onsemi
Series:	Product Status:
PowerTrench®	Active
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
100 V	75A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
10V	10mOhm @ 75A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
4.5V @ 250μA	100 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	7300 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	208W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 175°C (TJ)	Through Hole
Supplier Device Package:	Package / Case:
TO-220-3	TO-220-3
Base Product Number:	
FDP100	

# **Environmental & Export classification**

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	Not Applicable
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	



# **MOSFET** – N-Channel, POWERTRENCH®

100 V, 75 A, 10 m $\Omega$ 

# **FDP100N10**

# Description

This N-Channel MOSFET is Produced using **onsemi**'s advanced PowerTrench Process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

## **Features**

- $R_{DS(on)} = 8.2 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 75 \text{ A}$
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low R<sub>DS(on)</sub>
- High Power and Current Handling Capability
- This Device is Pb-Free Halide, Free and RoHS Compliant

# **Applications**

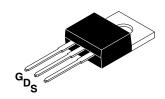
- Synchronous Rectification for ATX / Sever / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverter

## **ABSOLUTE MAXIMUM RATINGS**

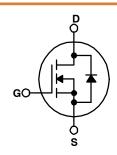
(T<sub>C</sub> = 25°C unless otherwise noted.)

Symbol	Parameter	Value	Unit
V <sub>DSS</sub>	Drain to Source Voltage	100	V
V <sub>GSS</sub>	Gate to Source Voltage	±20	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 75°C)	75	Α
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	300	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	365	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	6	V/ns
P <sub>D</sub>	Power Dissipation – (T <sub>C</sub> = 25°C) – Derate Above 25°C	208 1.4	W W/°C
T <sub>J</sub> ,T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +175	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



TO-220-3LD CASE 340AT



# **MARKING DIAGRAM**

&Z&3&K FDP 100N10

&Z = Assembly Plant Code &3 = 3-Date Date Code

&K = 2-Date Lot Run Traceability Code

FDP100N10 = Specific Device Code

### **ORDERING INFORMATION**

Device	Package	Shipping
FDP100N10	TO-220-3 FullPack	800 Units / Tube

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case, Max.	0.72	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Charac	teristics				•	
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V, T_J = 25^{\circ}C$	100	_	_	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25°C	-	0.1	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V	_	_	1	μΑ
ı		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V T <sub>C</sub> = 150°C	_	_	500	
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V	_	_	±100	nA
On Charac	teristics				•	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.5	_	4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 75 A	_	8.2	10	mΩ
9FS	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 37.5 A	_	110	-	S
Dynamic C	Characteristics					
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	5500	7300	pF
Coss	Output Capacitance		_	530	710	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		_	220	325	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 75 A, V <sub>GS</sub> = 10 V	-	76	100	nC
$Q_{gs}$	Gate to Source Gate Charge	(Note 4)	_	30	_	nC
$Q_{gd}$	Gate to Drain "Miller" Charge		_	20	_	nC
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 50 \text{ V}, I_D = 75 \text{ A},$	_	70	150	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, R_G = 25 \Omega \text{ (Note 4)}$	_	265	540	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		_	125	260	ns
t <sub>f</sub>	Turn-Off Fall Time		_	115	240	ns
Drain-Sou	rce Diode Characteristics and Maximum F	Ratings				
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		_	_	75	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		_	_	300	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 75 A	_	_	1.25	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 75 A,	_	71	_	ns
$Q_{rr}$	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 A/μs	_	164	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 1. Repetitive Rating: Pulse–width limited by maximum junction temperature. 
  2. L = 0.13 mH,  $I_{AS}$  = 75 A,  $V_{DD}$  = 25 V,  $R_{G}$  = 25  $\Omega$  starting  $T_{J}$  = 25°C. 
  3.  $I_{SD} \le$  75 A, di/dt  $\le$  200 A/ $\mu$ s,  $V_{DD} \le$  BV $_{DSS}$ , starting  $T_{J}$  = 25°C. 
  4. Essentially independent of operating temperature typical characteristics.

## TYPICAL CHARACTERISTICS

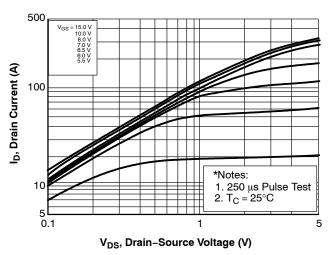


Figure 1. On-Region Characteristics

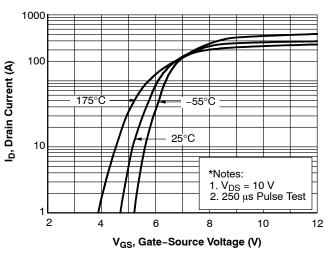


Figure 2. Transfer Characteristics

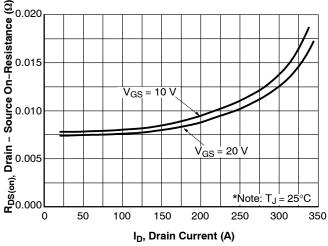


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

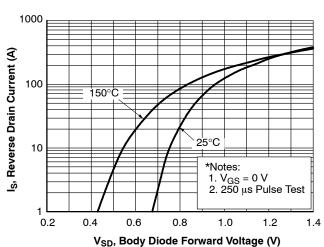


Figure 4. Body Diode Forward Voltage Variation vs Source Current and Temperature

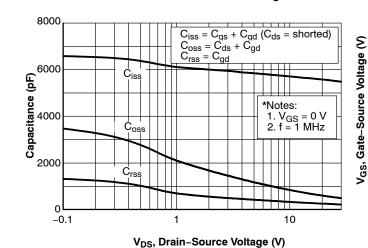


Figure 5. Capacitance Characteristics

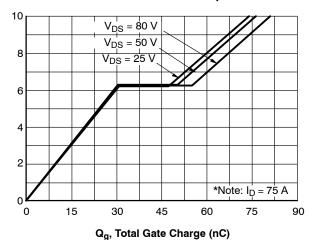
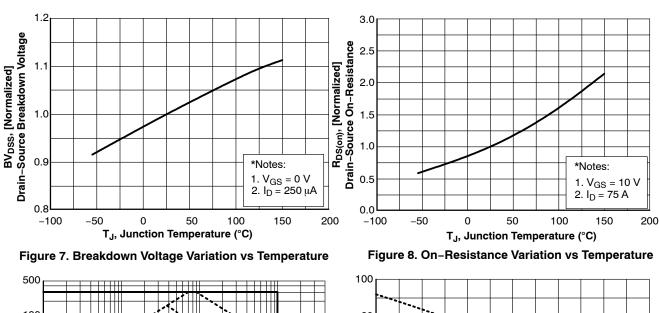


Figure 6. Gate Charge Characteristics

# TYPICAL CHARACTERISTICS (continued)



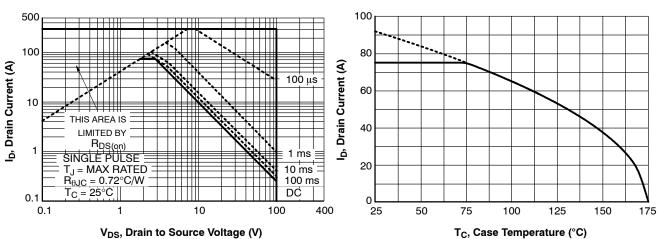


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

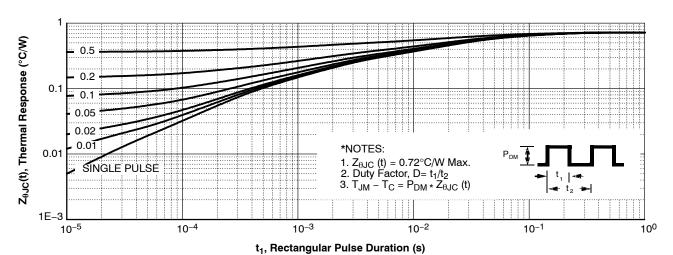


Figure 11. Transient Thermal Response Curve

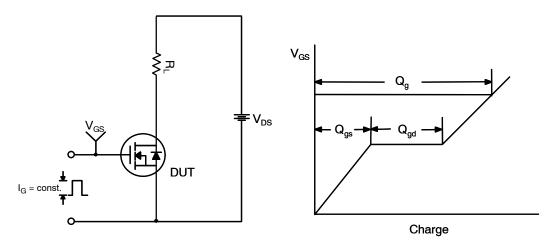


Figure 12. Gate Charge Test Circuit & Waveform

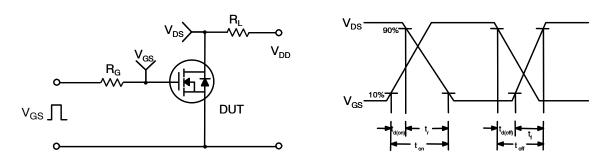


Figure 13. Resistive Switching Test Circuit & Waveforms

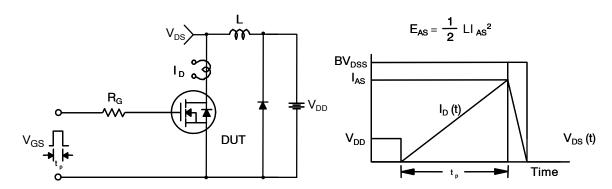
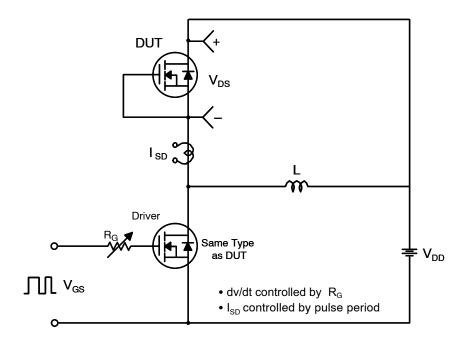
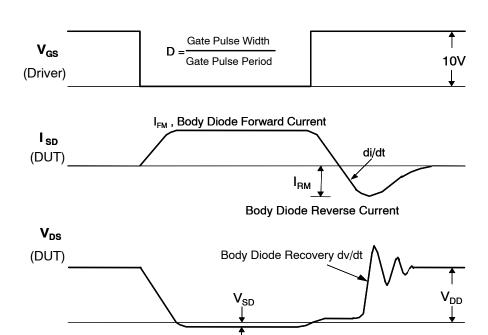


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





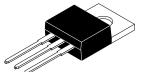
Forward Voltage Drop

Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

**Body Diode** 

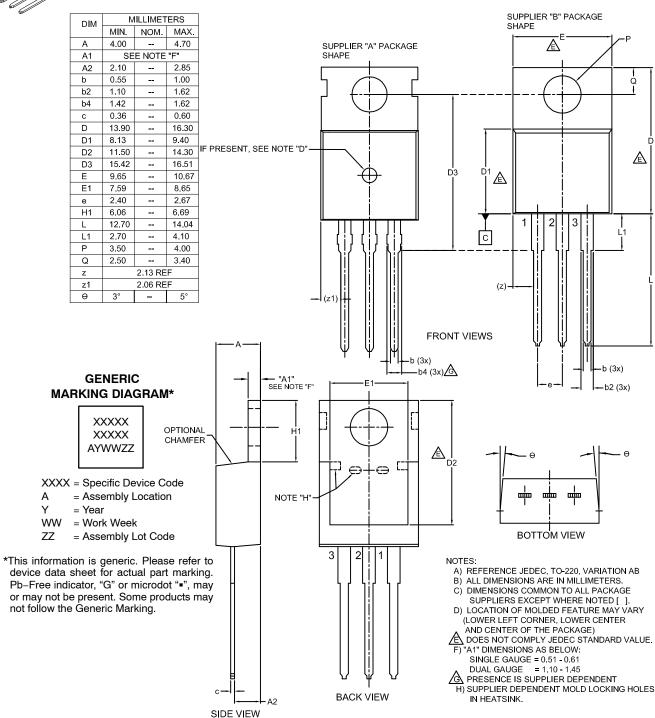


# **MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS**



# TO-220-3LD CASE 340AT **ISSUE B**

### **DATE 08 AUG 2022**



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